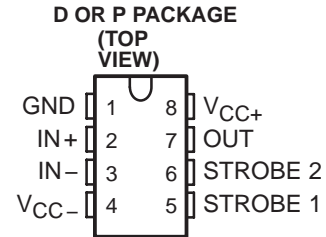


# LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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- Fast Response Times
- Improved Gain and Accuracy
- Fanout to 10 Series 54/74 TTL Loads
- Strobe Capability
- Short-Circuit and Surge Protection
- Designed to Be Interchangeable With National Semiconductor LM306



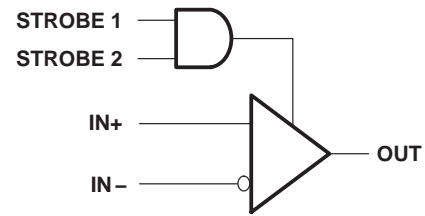
## description

The LM306 is a high-speed voltage comparator with differential inputs, a low-impedance high-sink-current (100 mA) output, and two strobe inputs. This device detects low-level analog or digital signals and can drive digital logic or lamps and relays directly. Short-circuit protection and surge-current limiting is provided.

A low-level input at either strobe causes the output to remain high regardless of the differential input. When both strobe inputs are either open or at a high logic level, the output voltage is controlled by the differential input voltage. The circuit will operate with any negative supply voltage between -3 V and -12 V with little difference in performance.

The LM306 is characterized for operation from 0°C to 70°C.

## functional block diagram



## AVAILABLE OPTIONS

T <sub>A</sub>	V <sub>IO</sub> max at 25°C	PACKAGE	
		SMALL OUTLINE (D)	PLASTIC DIP (P)
0°C to 70°C	5 mV	LM306D	LM306P

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



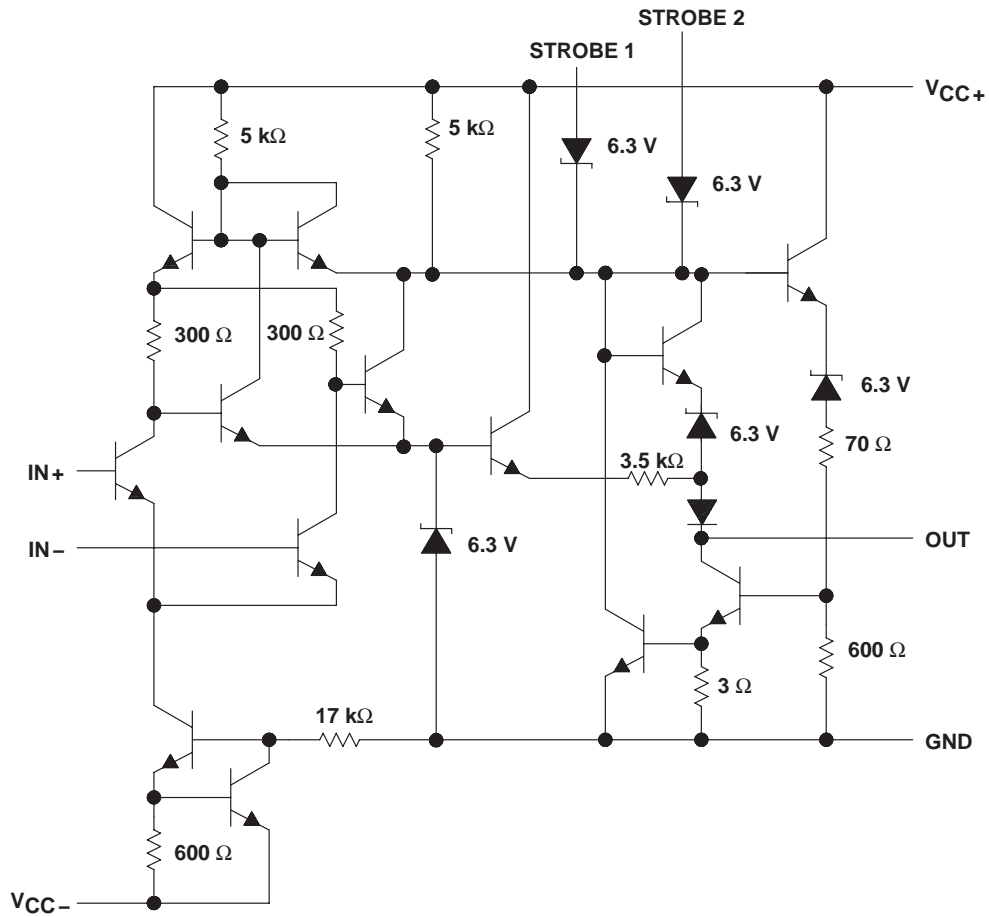
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# LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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## schematic



Resistor values are nominal.

# LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, $V_{CC+}$ (see Note 1) .....	15 V
Supply voltage, $V_{CC-}$ (see Note 1) .....	-15 V
Differential input voltage, $V_{ID}$ (see Note 2) .....	$\pm 5$ V
Input voltage, $V_I$ (either input, see Notes 1 and 3) .....	$\pm 7$ V
Strobe voltage range (see Note 1) .....	0 V to $V_{CC+}$
Output voltage, $V_O$ (see Note 1) .....	24 V
Voltage from output to $V_{CC-}$ .....	30 V
Duration of output short circuit to ground (see Note 4) .....	10 s
Continuous total dissipation .....	See Dissipation Rating Table
Operating free-air temperature range, $T_A$ .....	$0^\circ\text{C}$ to $70^\circ\text{C}$
Storage temperature range .....	$-65^\circ\text{C}$ to $150^\circ\text{C}$
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds .....	$260^\circ\text{C}$

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages and the voltage from the output to  $V_{CC-}$ , are with respect to the network ground.
  2. Differential voltages are at  $IN+$  with respect to  $IN-$ .
  3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 7 V, whichever is less.
  4. The output may be shorted to ground or either power supply.

**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR	DERATE ABOVE $T_A$	$T_A = 70^\circ\text{C}$ POWER RATING
D	600 mW	5.8 mW/ $^\circ\text{C}$	$46^\circ\text{C}$	464 mW
P	600 mW	8.0 mW/ $^\circ\text{C}$	$75^\circ\text{C}$	600 mW



# LM306

## DIFFERENTIAL COMPARATOR WITH STROBES

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electrical characteristics at specified free-air temperature,  $V_{CC+} = 12\text{ V}$ ,  $V_{CC-} = -3\text{ V}$  to  $-12\text{ V}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	$T_A$ ‡	MIN	TYP	MAX	UNIT	
$V_{IO}$	Input offset voltage	$R_S \leq 200\ \Omega$	25°C		1.6§	5	mV	
			Full range			6.5		
$\alpha_{VIO}$	Average temperature coefficient of input offset voltage	$R_S = 50\ \Omega$ , See Note 5	Full range		5	20	$\mu\text{V}/^\circ\text{C}$	
$I_{IO}$	Input offset current	See Note 5	25°C		1.8	5	$\mu\text{A}$	
			MIN		1	7.5		
			MAX		0.5	5		
$\alpha_{IIO}$	Average temperature coefficient of input offset current	See Note 5	MIN to 25°C		24	100	$\text{nA}/^\circ\text{C}$	
			25°C to MAX		15	50		
$I_{IB}$	Input bias current	$V_O = 0.5\text{ V}$ to $5\text{ V}$	MIN to 25°C			40	$\mu\text{A}$	
			25°C to MAX		16	25		
$I_{IL(S)}$	Low-level strobe current	$V(\text{strobe}) = 0.4\text{ V}$	Full range		-1.7	-3.2	mA	
$V_{IH(S)}$	High-level strobe voltage		Full range	2.2			V	
$V_{IL(S)}$	Low-level strobe voltage		Full range			0.9	V	
$V_{ICR}$	Common-mode input voltage range	$V_{CC-} = -7\text{ V}$ to $-12\text{ V}$	Full range	$\pm 5$			V	
$V_{ID}$	Differential input voltage range		Full range	$\pm 5$			V	
$A_{VD}$	Large-signal differential voltage amplification	$V_O = 0.5\text{ V}$ to $5\text{ V}$ , No load	25°C		40		V/mV	
$V_{OH}$	High-level output voltage	$I_{OH} = -400\ \mu\text{A}$ $V_{ID} = 8\text{ mV}$	Full range	2.5		5.5	V	
$V_{OL}$	Low-level output voltage	$I_{OL} = 100\text{ mA}$ $V_{ID} = -7\text{ mV}$	25°C		0.8	2	V	
		$I_{OL} = 50\text{ mA}$ $V_{ID} = -7\text{ mV}$	Full range			1		
		$I_{OL} = 16\text{ mA}$ $V_{ID} = -8\text{ mV}$	Full range					0.4
$I_{OH}$	High-level output voltage	$V_{OH} = 8\text{ V}$ to $24\text{ V}$	$V_{ID} = 7\text{ mV}$	MIN to 25°C		0.02	2	$\mu\text{A}$
			$V_{ID} = 8\text{ mV}$	25°C to MAX				
$I_{CC+}$	Supply current from $V_{CC+}$	$V_{ID} = -5\text{ mV}$ , No load	Full range		6.6	10	mA	
$I_{CC-}$	Supply current from $V_{CC-}$	No load	Full range		-1.9	-3.6	mA	

† Unless otherwise noted, all characteristics are measured with both strobes open.

‡ Full range is 0°C to 70°C. MIN is 0°C. MAX is 70°C.

§ This typical value is at  $V_{CC+} = 12\text{ V}$ ,  $V_{CC-} = -6\text{ V}$ .

NOTE 5: The offset voltages and offset currents given are the maximum values required to drive the output down to the low range ( $V_{OL}$ ) or up to the high range ( $V_{OH}$ ). These parameters actually define an error band and take into account the worst-case effects of voltage gain and input impedance.

### switching characteristics, $V_{CC+} = 12\text{ V}$ , $V_{CC-} = -6\text{ V}$ , $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS†	MIN	TYP	MAX	UNIT
Response time, low-to-high-level output	$R_L = 390\ \Omega$ to $5\text{ V}$ , $C_L = 15\text{ pF}$ , See Note 6		28	40	ns

† All characteristics are measured with both strobes open.

NOTE 6: The response time specified is for a 100-mV input step with 5-mV overdrive and is the interval between the input step function and the instant when the output crosses 1.4 V.

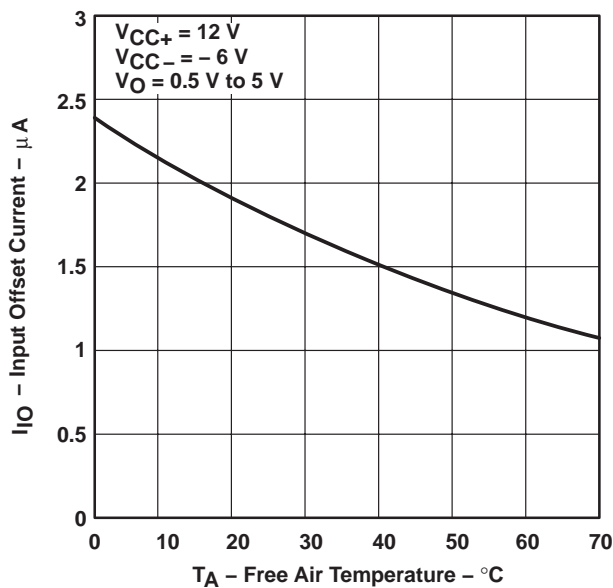


**TYPICAL CHARACTERISTICS**

**Table of Graphs**

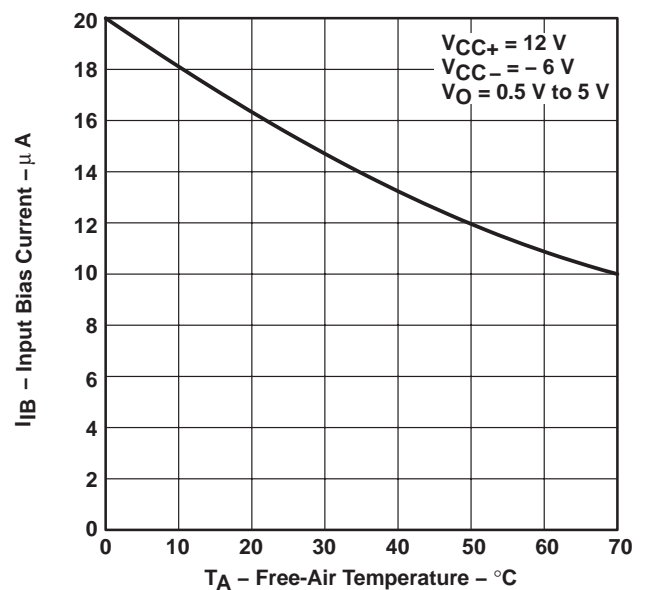
			FIGURE
$I_{IB}$	Input bias current	vs Free-air temperature	1
$I_{IO}$	Input offset current	vs Free-air temperature	2
$V_{OH}$	High-level output voltage	vs Free-air temperature	3
$V_{OL}$	Low-level output voltage	vs Free-air temperature	4
$V_O$	Output voltage	vs Differential input voltage	5
$I_O$	Output current	vs Differential input voltage	6
$A_{VD}$	Large-signal differential voltage amplification	vs Free-air temperature	7
$I_{OS}$	Short-circuit output current	vs Free-air temperature	8
	Output response	vs Time	9, 10
$I_{CC+}$	Positive supply current	vs Positive supply voltage	11
$I_{CC-}$	Negative supply current	vs Negative supply voltage	12
$P_D$	Total power dissipation	vs Free-air temperature	13

**INPUT OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE**



**Figure 1**

**INPUT BIAS CURRENT  
vs  
FREE-AIR TEMPERATURE**



**Figure 2**

# LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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## TYPICAL CHARACTERISTICS

HIGH-LEVEL OUTPUT VOLTAGE  
vs  
FREE-AIR TEMPERATURE

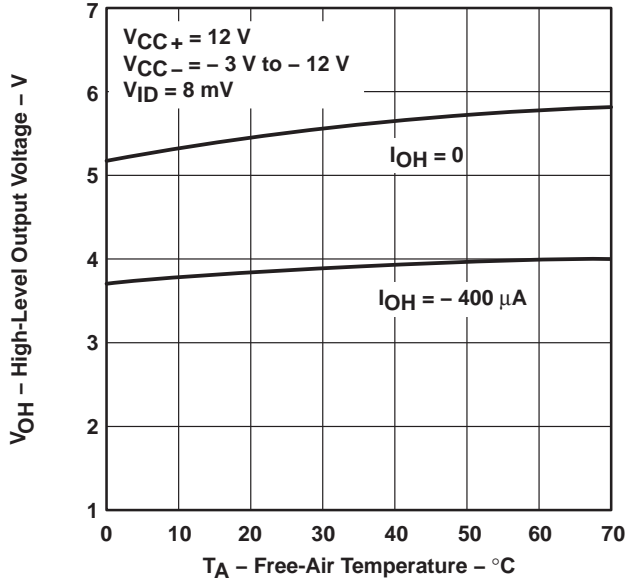


Figure 3

LOW-LEVEL OUTPUT VOLTAGE  
vs  
FREE-AIR TEMPERATURE

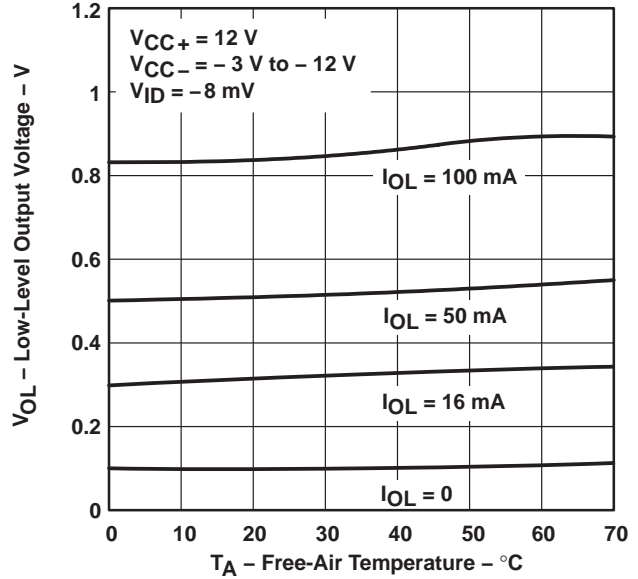


Figure 4

OUTPUT VOLTAGE  
vs  
DIFFERENTIAL INPUT VOLTAGE

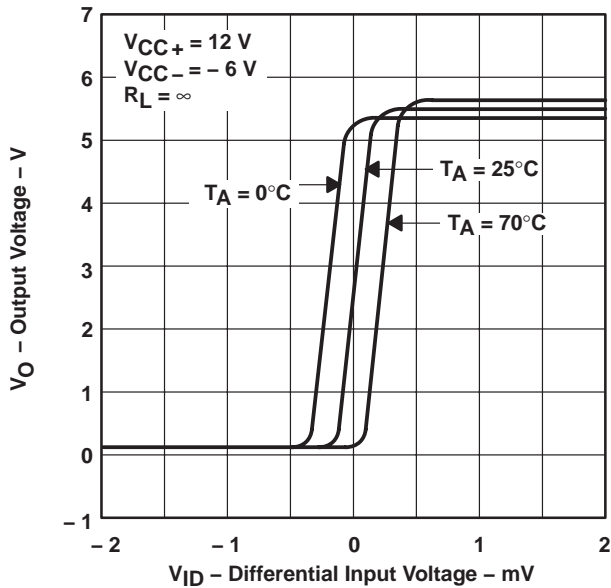


Figure 5

OUTPUT CURRENT  
vs  
DIFFERENTIAL INPUT VOLTAGE

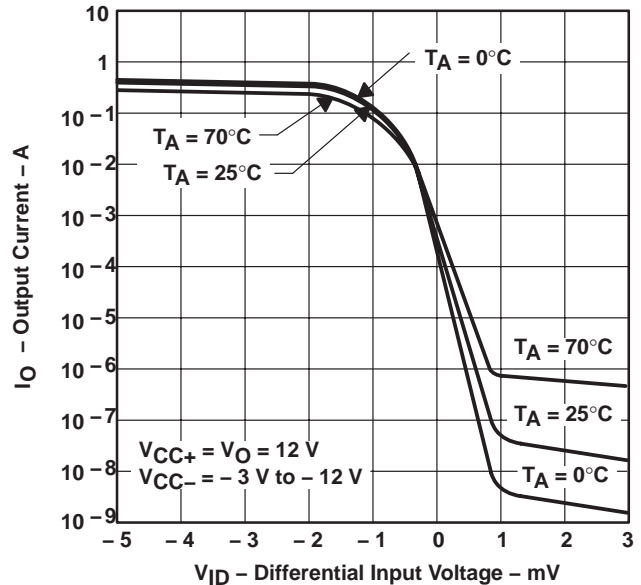
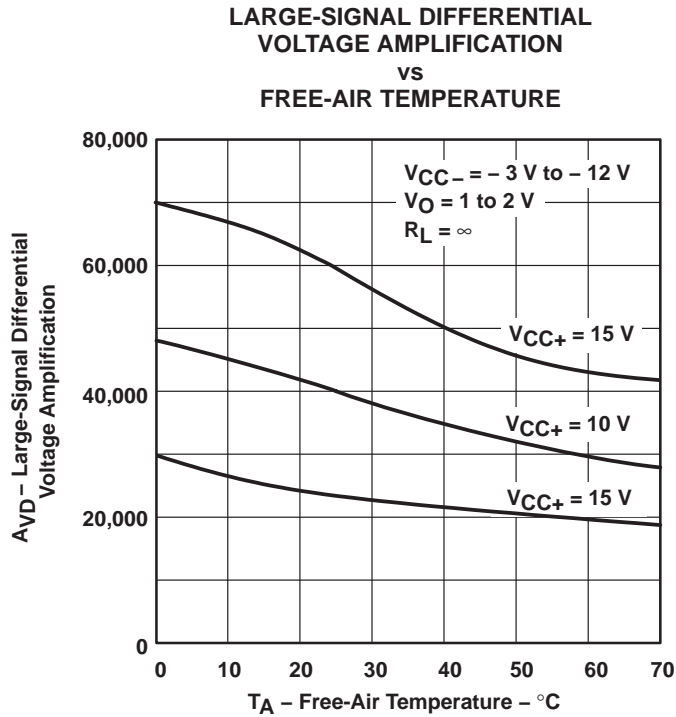


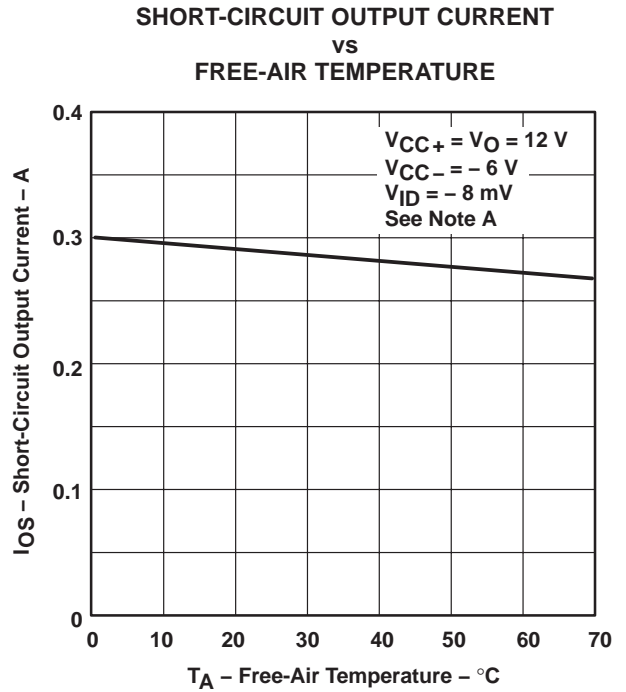
Figure 6



**TYPICAL CHARACTERISTICS**

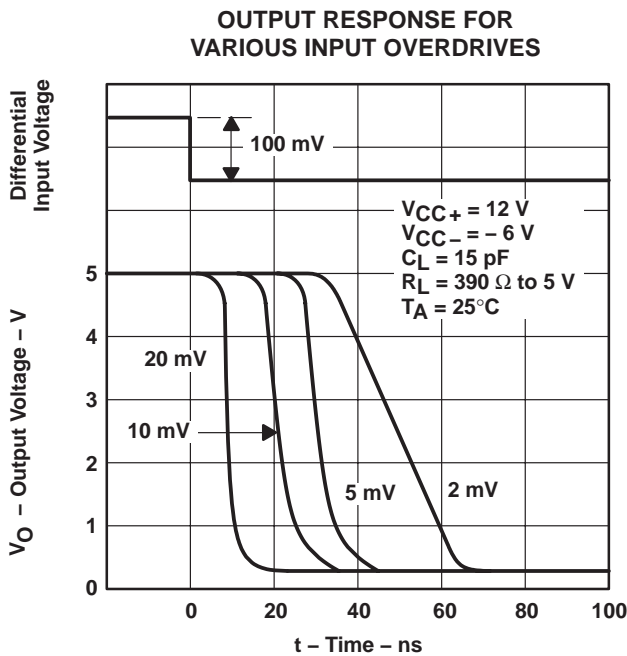


**Figure 7**

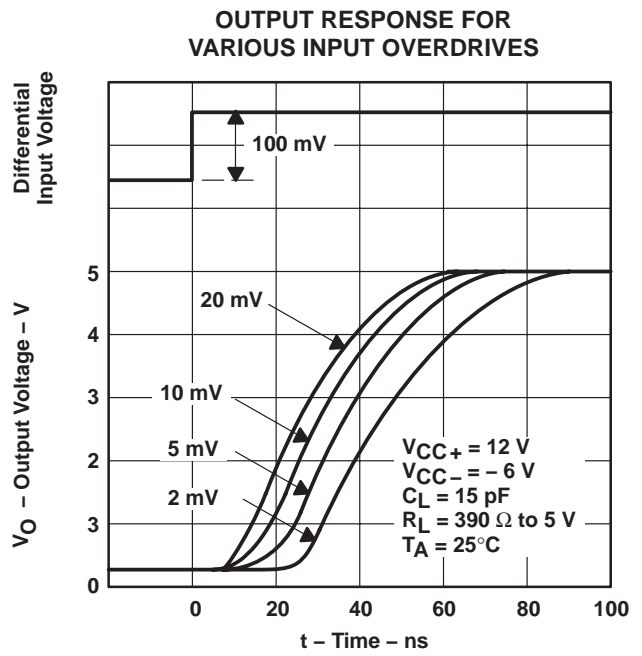


NOTE A: This parameter was measured using a single 5-ms pulse.

**Figure 8**



**Figure 9**



**Figure 10**

# LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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## TYPICAL CHARACTERISTICS

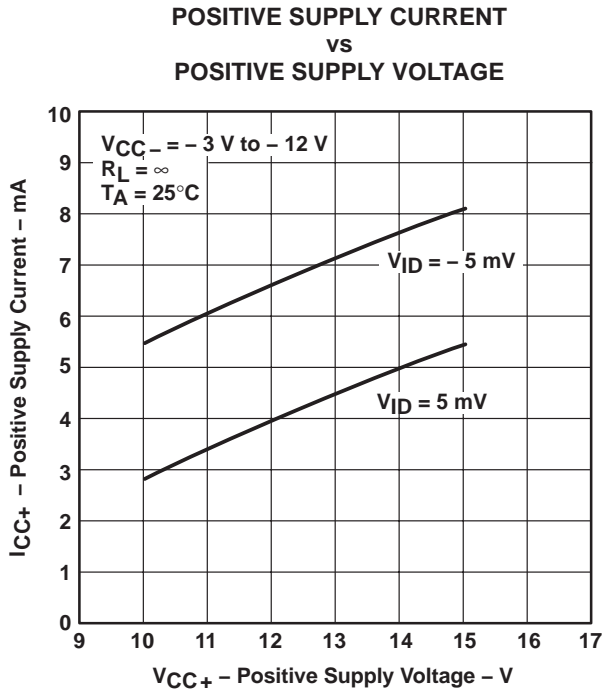


Figure 11

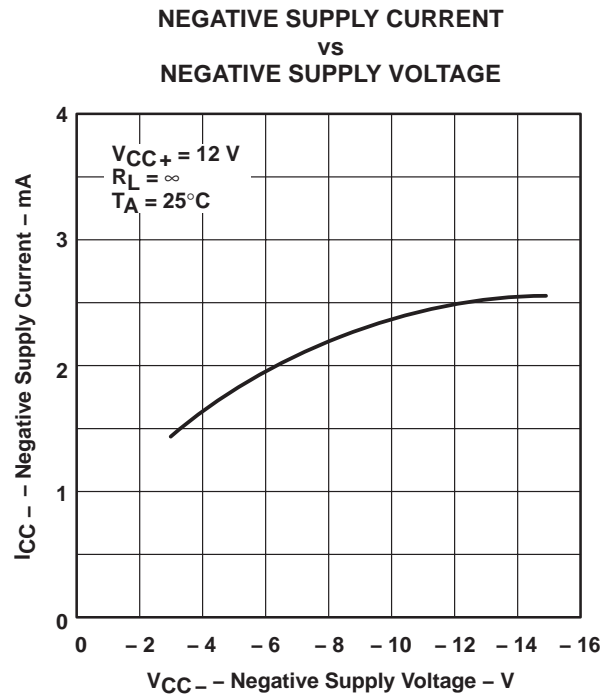


Figure 12

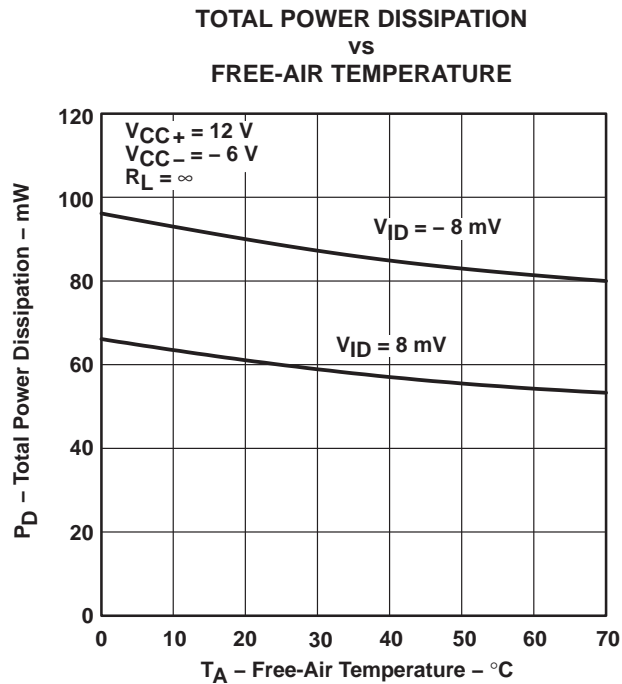


Figure 13





**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM306D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LM306	<a href="#">Samples</a>
LM306DR	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	0 to 70		
LM306DRE4	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	0 to 70		
LM306DRG4	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	0 to 70		
LM306P	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	LM306P	<a href="#">Samples</a>
LM306PE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	LM306P	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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